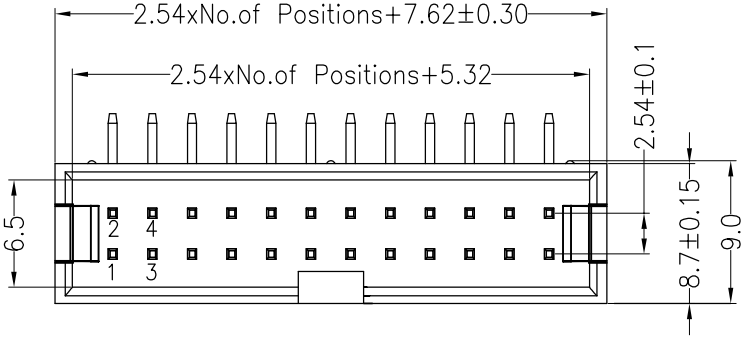
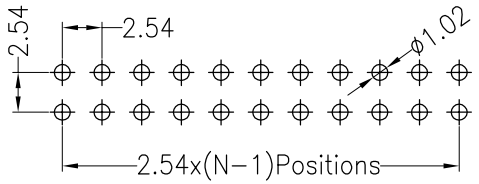
HSF RoHS

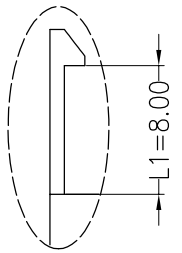
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°C to +105°C

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)

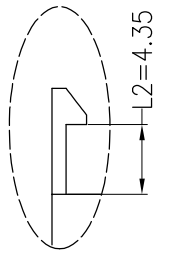


Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)





Long Latch

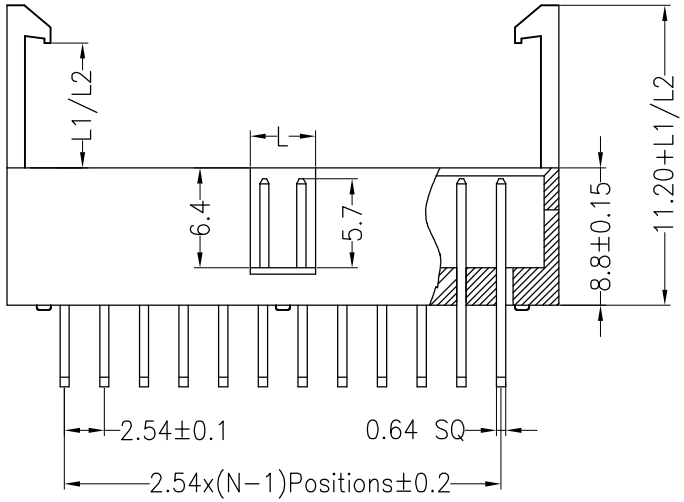


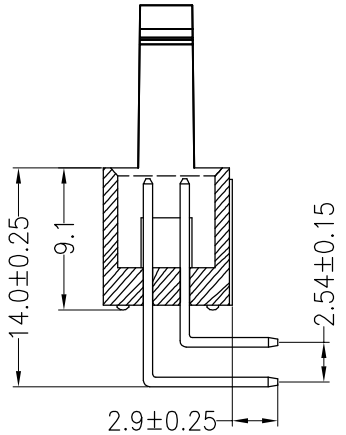
Short Latch

Ordering Information

3215 XX R XX X B K00 X 0 X

- XX: No.of Pins 6−−64
- XX: Contact Plating
  G0:Gold Flash
  G1:1U" Gold
  G2:1.5U" Gold
  G3:2U" Gold
  G4:3U" Gold
  G5:5U" Gold
  S0:Gold Flash/Tin
  SN:Tin
- X: Insulator Material Option
  A=BK−PBT
  C=BK−PA6T
  D=BK−PA46
  E=BK−PA9T
  F=BK−LCP
- X: Packing
  T=Tube
  A=Tray
  P=Tube+Cap





L	
6P~8P	10P~64P
4.00	4.40

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2019.03.14	NEW DRAWING	

OPERATION		DRAW	Liu Miao	19.04.20	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	3215XXRXXXBK00X0X
TITLE:	2.54mm Box Header H8.8mm 90° L=16.0/21.0